| Electronic Patent Application Fee Transmittal | | | | | | | | |
|--|-------------------------------------|----------|----------|--------|-------------------------|--|--|--|
| Application Number: | 10562116 | | | | | | | |
| Filing Date: | 23-Dec-2005 | | | | | | | |
| Title of Invention: | ELECTROCONDUCTIVE RESIN COMPOSITION | | | | | | | |
| First Named Inventor/Applicant Name: | Takayuki Miyashita | | | | | | | |
| Filer: | Benton S. Duffett/Jean Bayou | | | | | | | |
| Attorney Docket Number: | 009760-028 | | | | | | | |
| Filed as Large Entity | | | | | | | | |
| U.S. National Stage under 35 USC 371 Filing Fees | | | | | | | | |
| Description | | Fee Code | Quantity | Amount | Sub-Total in USD(\$) | | | |
| Basic Filing: | | | | | | | | |
| Pages: | | | | | | | | |
| Claims: | | | | | | | | |
| Miscellaneous-Filing: | | | | | | | | |
| Petition: | | | | | | | | |
| Patent-Appeals-and-Interference: | | | | | | | | |
| Post-Allowance-and-Post-Issuance: | | | | | | | | |
| Utility Appl issue fee | | 1501 | 1 | 1510 | 1510 | | | |
| Publ. Fee- early, voluntary, or normal | | 1504 | 1 | 300 | 300 | | | |

| Description | Fee Code | Quantity | Amount | Sub-Total in USD(\$) |
|--------------------|-------------------|----------|--------|-------------------------|
| Extension-of-Time: | | | | |
| Miscellaneous: | | | | |
| | Total in USD (\$) | | | 1810 |